

深圳市长江微电科技有限公司

SZ CJIANG TECHNOLOGY CO.,LTD

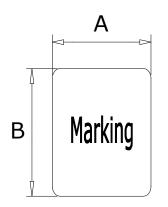
Introduction

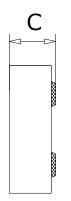
- •Soft saturation.
- •High current, low DCR, high efficiency.
- •Very low acoustic noise and very low leakage flux noise.
- ·High reliability.
- •100% Lead(Pb)-Free and RoHS compliant.
- •Operating temperature -55~+125°C (Including self temperature rise)

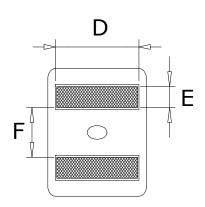
Applications

- Note PC power system, incl. IMVP-6
- DC/DC converter

Dimensions (Unit: mm)





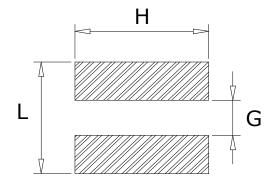




RoHS

compliant

Code	Dimensions(mm)
Α	16.5±0.3
В	15.5±0.3
С	7.7±0.3
D	13.2±0.5
Е	3.2±0.3
F	7.0±0.5



L	15.0ref
Н	15.0ref
G	6.0ref

Unit: mm

Recommend Land Pattern



Marking

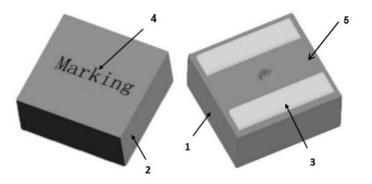
Note: Using Ink for marking

Marking

Marking:

Example	Nominal Value
0.18µH	R18
1.2 µH	1R2
4.5 µH	4R5

Structure and Components



NO	Components	Material
1	CORE	Alloy Powder
2	WIRE	Polyester Wire or equivalent.
3	Clip	100% Pb free solder
4	Ink	Halogen-free ketone
5	paint	Epoxy resin



Specification

		DCR (mΩ)	Isat (A)		Irms (A)Typ	
Part No.	L0 (µH)±20 %	MAX	Max	Тур	20℃ rise	40℃ rise
FEXL1580A-2R0M	2.00	2.21	52.0	57.0	29.5	40.0
FEXL1580A-2R2M	2.20	2.48	49.0	55.0	28.0	37.0
FEXL1580A-3R0M	3.00	3.00	41.0	46.0	26.0	34.5
FEXL1580A-4R2M	4.20	4.68	33.0	38.0	20.5	27.0
FEXL1580A-5R3M	5.30	5.34	31.0	35.0	19.5	26.0
FEXL1580A-6R2M	6.20	6.50	31.0	34.0	17.0	23.0
FEXL1580A-7R2M	7.20	7.20	29.0	32.0	15.0	21.0
FEXL1580A-8R2M	8.20	7.92	25.0	28.0	13.0	19.0

Notes:

- 1. Test frequency : L : 100KHz /0.1V;
- 2. All test in 25 °C temperature.
- 3.Testing Instrument:L:HP4285A,CH11025,CH3302,CH1320,CH1320S LCR METER / Rdc:CH16502, MICRO OHMMETER.
- 4.Heating Rating Current (Irms) will cause the coil temperature rise of 40 $^{\circ}\mathrm{C}$ approximately (Δt);
- 5. Saturation Current (Isat) will cause L0 to drop 30% approximately.
- 6.The part temperature (ambient + temp rise) should not exceed 125°C under the worst case operating condition. Circuit design, component,

PCB trace size and thickness airflow and other cooling provisions all could affect the part temperature. Part temperature should be verified in the end application.

7. Special inquiries besides the above common used types can be met on your requirement.



DCR Test



Mechanical Relia	ability	
Item	Specification and Requirement	Test Method
Solderability	 No case deformation or change in visual New solder coverage More than 95% 	1.Preheat: $155^{\circ}C\pm5^{\circ}C$, $60S\pm2S$ 2.Tin: lead-free. 3.Temperature:240 $^{\circ}C\pm5^{\circ}C$, flux 3.0S \pm 0.5S.
Mechanical shock	1. No case deformation or change in visual2. △L/Lo ≦ ± 10%	 Acceleration: 100G Pulse time:: 6ms 3 times in each positive and negative direction of 3 mutual perpendicular directions
Mechanical vibration	 1. No case deformation or change in visual 2. △L/Lo ≤ ±10% 	 Reflow: 2times Frequency: 10HZ~50HZ~10HZ, 20 Min/Cycles Amplitude: 1.52 mm±10% Directions: X,Y,Z Time: 12 cycle / direction
Endurance Relia	bility	
Item	Specification and Requirement	Test Method
Thermal Shock	Inductance change: Within \pm 10% Without distinct damage in visual	 First -55°C for 30 minutes, last 125°C for 30 minutes as 1 cycle. Go through 1000 cycles. Max transfer time is 3 minutes. Measured at room temperature after placing for 24±2 hours
Humidity Resistance	Inductance change: Within \pm 10% Without distinct damage in visual	1.Reflow 2 times, $2.85^\circ\!$
Low temperature storage	Inductance change: Within \pm 10% Without distinct damage in visual	1. Temperature: -55 \pm 2°C 2. Time: 1000 hours 3. Measured at room temperature after placing for 24 \pm 2 hours
High temperature storage	Inductance change: Within \pm 10% Without distinct damage in visual	1. Temperature: +125 \pm 2°C 2. Time: 1000 hours 3. Measured at room temperature after placing for 24 \pm 2 hours



Recommended Soldering Technologies

(1)Re-flowing Profile

Preheat condition: 150 ~200 °C/60~120sec.

Allowed time above 217°C: 60~90sec.

Peak temp: 260°C

Max time at Peak temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max

(2)Iron Soldering Profile

Iron soldering power: Max. 30W

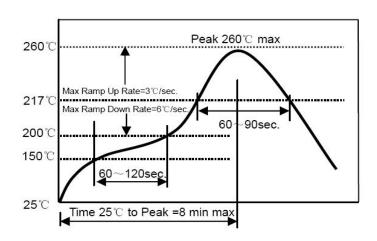
Pre-heating: 150°C/60sec.

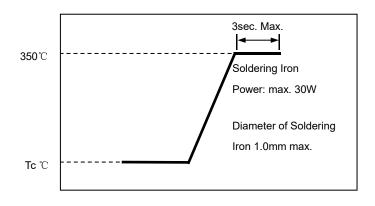
Soldering Tip temperature: 350 ℃ Max.

Soldering time: 3sec. Max.

Solder paste: Sn/3.0Ag/0.5Cu

Max.1 times for iron soldering

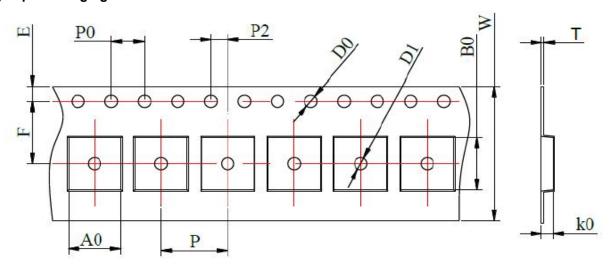






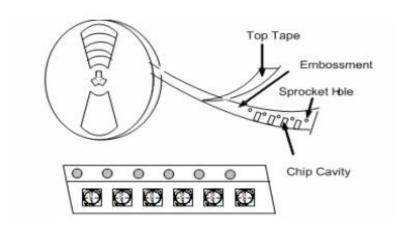
Packaging Information

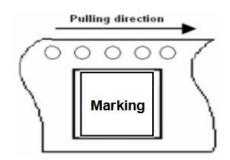
(1) Tape Packaging Dimensions (Unit: mm)



	Tape dimensions (mm)										
W	Р	P0	P2	D0	D1	Т	A0	В0	K0	E	F
32 ±0.3	24 ±0.1	4.0 ±0.1	2.0 ±0.1	1.5 ±0.1	1.5 ±0.1	0.5 ±0.05	17 ±0.1	16 ±0.1	8.5 ±0.1	1.75 ±0.1	14.2 ±0.1

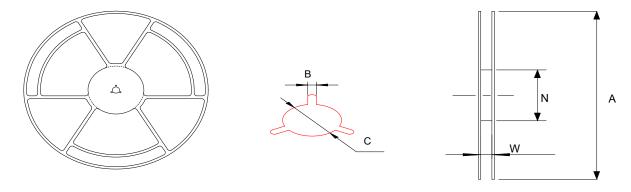
Taping Drawings (UNIT:mm)







(2) Reel Dimensions (Unit: mm)



А	w	N	В	С
330±2.0	32.0±0.5	97±0.5	2.3±0.3	13.0±0.2

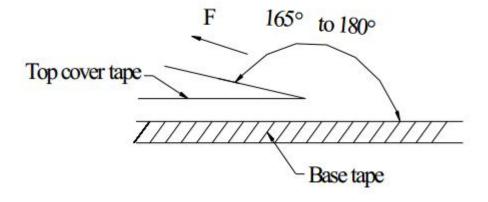
(3) Packaging Quantity

Standard Quantity				
Reel Inner box Carton box				
200 pcs / reel	2Reel / box (400 pcs)	3 Middle boxes, (1200 pcs)		

(4) Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N





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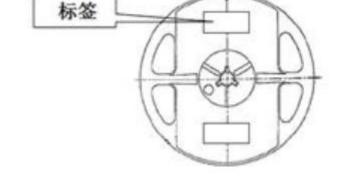
(5) Reel Label

Label on the reel

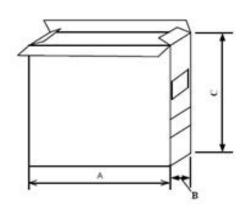
- Customer's part Number
- Lot Number
- Quantity
- date code

Shipping Label

- Customer's part Number
- Manufacturer's part Number
- Quantity
- date code

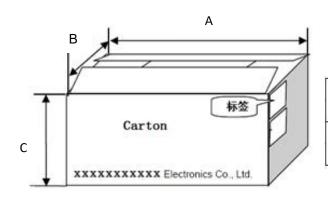


(6) Inner Box



Packaging type	A (non.)	B (non.)	C (nun.)
lnner box	335	70	340

(7) Carton



Packaging type	A (mm)	B (mm)	C (mm)	
type	360	360	360	



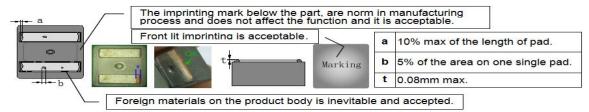
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Appearance criterion

1. PAD residual powder, inner wire exposed, imprinting

The residual powder on both side of pad is norm and within following criteria are acceptable.



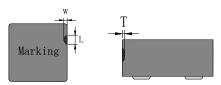
2. Defects

Chip off is generated during molding and manufacturing process.

Chip off acceptance limits subjected to the product size.

Our current Defect limit is based on the IPC-A-610.

Some chip off does not impact the product function, see the IPC standard 1 & 2.



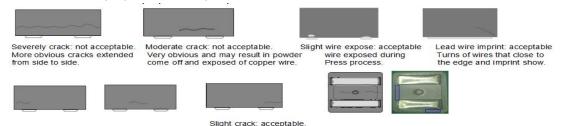
Т	≤10% of the thickness	Each surface can only accept
W	≤10 % of the width	one minor chip off,and more than 3
L	<10.0/ of the length	chip off problems are not allowed on
	≤10 % of the length	the same product.

Defects usually occur at the corners and edges of the product, There will be a slight defect black and rough, but not exposed copper, and does not affect the product performance and reliability.

3、Crack

Production process of cracks appearing in the body is inevitable, some slight crack is caused because the molding, is not oxidized, crack on the product will not affect product performance.

We have done a reliability test of crack products, even if cracks is more than 0.13mm also will not affect the electrical properties of the product, crack limits as follows:



Products from a slight crack in the baking process due to thermal expansion, and it is not obvious by visual inspection (Must not exceed the blue square area).

Cracks on the same side surface are not allowed to exceed 1/2 of the length of the side and the crack width cannot exceed 0.13mm, and only 1 crack is allowed on the same side.

Bottom cracks are not allowed to exceed 1/2 of the length (or width) of the corresponding body nor the Non-manufacturability swelling, and the crack width cannot be exceed 0.13mm, and less than 2 cracks are allowed and judged as good products.

Visible cracks and non-manufacturability bulging are not allowed on the front side.

4. oxidation(rust)

the contains iron composite, although the resin has a protective effect of oxidation, but there will be small amount of product that may occur oxidation, The oxidation area of each surface is allowed to be about 25% (in the case of non-reliability test), it is recommend that customer use this product in humidity controlled environment. The basic steps should be to protect the surface oxidation, including the sealed packages to PCB mount inductors. To avoid the adverse effects caused by oxidation, Oxidation occurs at the surface only allows the internal oxidation is not allowed, oxidized surface will not affect the reliability of the product.



4sides slightly oxidized side: Acceptable



Top and bottom slightly oxidized side: Acceptable

R33 R56 180 1601 1601

Spray printing effect : can be accepted if recognizable

Visual inspection: Examination with the naked eye, to distinguish from more technical modes of analysis employing tools or apparatus.